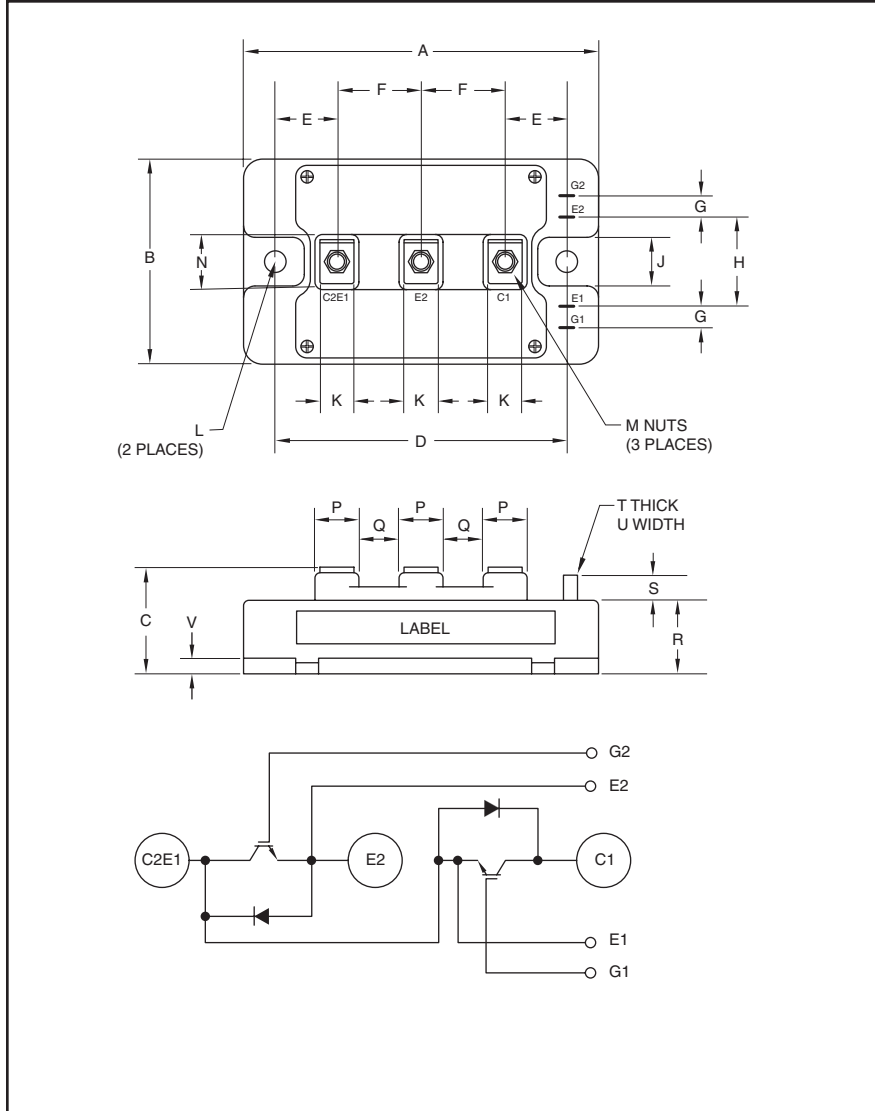


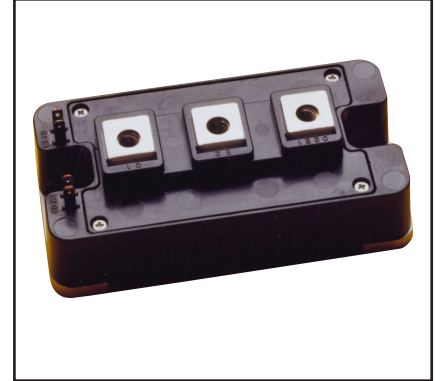
Dual IGBTMOD™ A-Series Module 200 Amperes/1200 Volts



Outline Drawing and Circuit Diagram

| Dimensions | Inches | Millimeters |
|------------|------------------|---------------|
| A | 3.70 | 94.0 |
| B | 1.89 | 48.0 |
| C | 1.14+0.004/-0.02 | 29.0+0.1/-0.5 |
| D | 3.15±0.01 | 80.0±0.25 |
| E | 0.67 | 17.0 |
| F | 0.91 | 23.0 |
| G | 0.16 | 4.0 |
| H | 0.71 | 18.0 |
| J | 0.51 | 13.0 |
| K | 0.47 | 12.0 |

| Dimensions | Inches | Millimeters |
|------------|-----------|-------------|
| L | 0.26 Dia. | Dia. 6.5 |
| M | M5 Metric | M5 |
| N | 0.79 | 20.0 |
| P | 0.63 | 16.0 |
| Q | 0.28 | 7.0 |
| R | 0.83 | 21.2 |
| S | 0.30 | 7.5 |
| T | 0.02 | 0.5 |
| U | 0.110 | 2.8 |
| V | 0.16 | 4.0 |



Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of two IGBT Transistors in a half-bridge configuration with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- Isolated Baseplate for Easy Heat Sinking

Applications:

- AC Motor Control
- UPS
- Battery Powered Supplies

Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM200DY-24A is a 1200V (V_{CES}), 200 Ampere Dual IGBTMOD™ Power Module.

| Type | Current Rating Amperes | V_{CES} Volts (x 50) |
|------|---------------------------|---------------------------|
| CM | 200 | 24 |



CM200DY-24A
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Absolute Maximum Ratings, $T_j = 25^\circ\text{C}$ unless otherwise specified

| Ratings | Symbol | CM200DY-24A | Units |
|---|------------------|-------------|------------------|
| Junction Temperature | T_j | -40 to 150 | $^\circ\text{C}$ |
| Storage Temperature | T_{stg} | -40 to 125 | $^\circ\text{C}$ |
| Collector-Emitter Voltage (G-E Short) | V_{CES} | 1200 | Volts |
| Gate-Emitter Voltage (C-E Short) | V_{GES} | ± 20 | Volts |
| Collector Current (DC, $T_C = 86^\circ\text{C}^*$) | I_C | 200 | Amperes |
| Peak Collector Current | I_{CM} | 400** | Amperes |
| Emitter Current*** ($T_C = 25^\circ\text{C}$) | I_E | 200 | Amperes |
| Peak Emitter Current*** | I_{EM} | 400** | Amperes |
| Maximum Collector Dissipation ($T_C = 25^\circ\text{C}^*$, $T_j \leq 150^\circ\text{C}$) | P_C | 1340 | Watts |
| Mounting Torque, M5 Main Terminal | — | 30 | in-lb |
| Mounting Torque, M6 Mounting | — | 40 | in-lb |
| Weight | — | 310 | Grams |
| Isolation Voltage (Main Terminal to Baseplate, AC 1 min.) | V_{ISO} | 2500 | Volts |

Static Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|---------------------------------------|---|--|------|------|------|---------------|
| Collector-Cutoff Current | I_{CES} | $V_{\text{CE}} = V_{\text{CES}}, V_{\text{GE}} = 0\text{V}$ | — | — | 1.0 | mA |
| Gate Leakage Current I_{GES} | $V_{\text{GE}} = V_{\text{GES}}, V_{\text{CE}} = 0\text{V}$ | — | — | 0.5 | — | μA |
| Gate-Emitter Threshold Voltage | $V_{\text{GE(th)}}$ | $I_C = 20\text{mA}, V_{\text{CE}} = 10\text{V}$ | 6.0 | 7.0 | 8.0 | Volts |
| Collector-Emitter Saturation Voltage | $V_{\text{CE(sat)}}$ | $I_C = 200\text{A}, V_{\text{GE}} = 15\text{V}, T_j = 25^\circ\text{C}$ | — | 2.1 | 3.0 | Volts |
| | | $I_C = 200\text{A}, V_{\text{GE}} = 15\text{V}, T_j = 125^\circ\text{C}$ | — | 2.4 | — | Volts |
| Total Gate Charge | Q_G | $V_{\text{CC}} = 600\text{V}, I_C = 200\text{A}, V_{\text{GE}} = 15\text{V}$ | — | 1000 | — | nC |
| Emitter-Collector Voltage** | V_{EC} | $I_E = 200\text{A}, V_{\text{GE}} = 0\text{V}$ | — | — | 3.8 | Volts |

Dynamic Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|----------------------------------|---------------------|---|------|------|------|---------------|
| Input Capacitance | C_{ies} | | — | — | 35 | nf |
| Output Capacitance | C_{oes} | $V_{\text{CE}} = 10\text{V}, V_{\text{GE}} = 0\text{V}$ | — | — | 3 | nf |
| Reverse Transfer Capacitance | C_{res} | | — | — | 0.68 | nf |
| Inductive | Turn-on Delay Time | $V_{\text{CC}} = 600\text{V}, I_C = 200\text{A},$ $V_{\text{GE}1} = V_{\text{GE}2} = 15\text{V}, R_G = 1.6\Omega,$ | — | — | 130 | ns |
| | Load | | | | | |
| Switch | Turn-off Delay Time | Inductive Load | — | — | 450 | ns |
| | Time | | | | | |
| Diode Reverse Recovery Time*** | t_{rr} | Switching Operation, | — | — | 150 | ns |
| Diode Reverse Recovery Charge*** | Q_{rr} | $I_E = 200\text{A}$ | — | 9.0 | — | μC |

* T_C, T_f measured point is just under the chips.

**Pulse width and repetition rate should be such that device junction temperature (T_j) does not exceed $T_{j(\text{max})}$ rating.

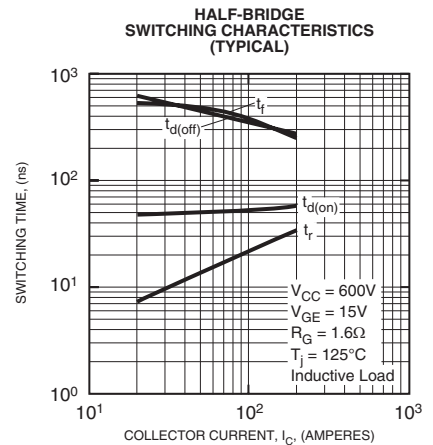
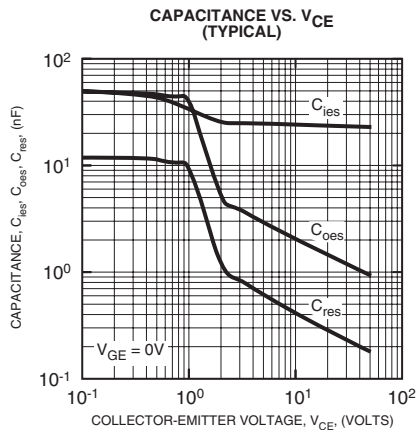
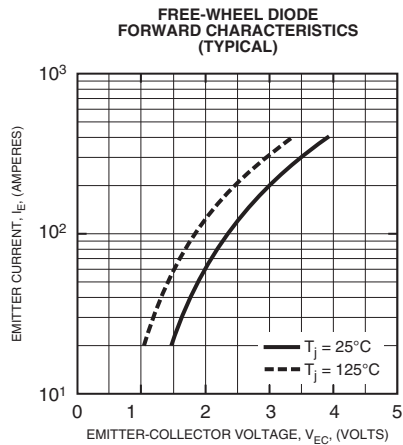
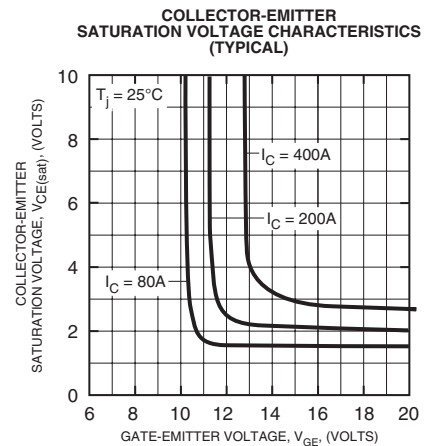
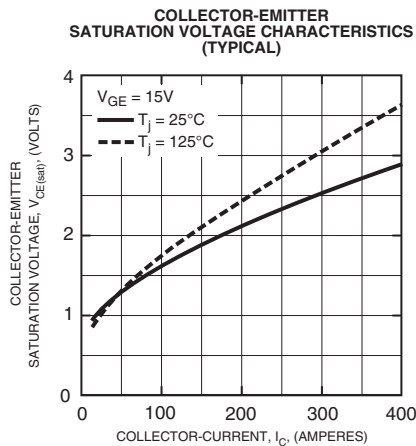
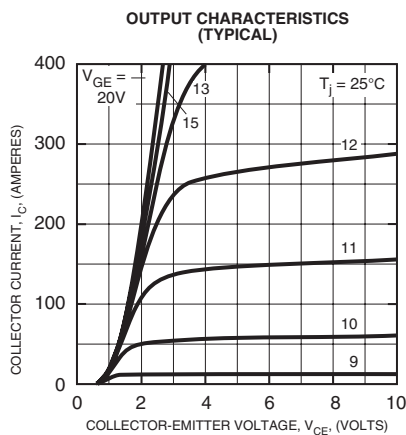
***Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDI).

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Thermal and Mechanical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|---------------------------------------|----------------|--|------|-------|-------|--------------------|
| Thermal Resistance, Junction to Case* | $R_{th(j-c)Q}$ | Per IGBT 1/2 Module | — | — | 0.093 | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction to Case* | $R_{th(j-c)D}$ | Per FWDi 1/2 Module | — | — | 0.17 | $^\circ\text{C/W}$ |
| Contact Thermal Resistance | $R_{th(c-f)}$ | Per 1/2 Module, Thermal Grease Applied | — | 0.022 | — | $^\circ\text{C/W}$ |
| External Gate Resistance | R_G | | 1.6 | — | 21 | Ω |

* T_C , T_f measured point is just under the chips.



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